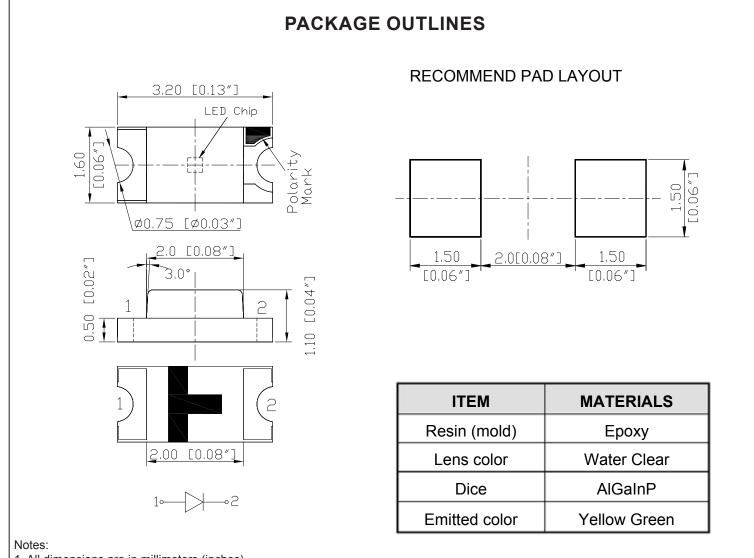


#### **SPECIFICATION**





1. All dimensions are in millimeters (inches).

2. Tolerance is ± 0.25mm (0.01") unless otherwised noted.

3. Specifications are subject to change without notice.

Part Number	Chip Material	Color of Emission	Lens Type	Viewing Angle
CS126AG2C-R	InGaAIP	Green	Water Clear	140°





## **ABSOLUTE MAXIMUM RATINGS**

#### (TA=25°C

Parameter	Symbol	Max Rating	Unit	
Forward Current	lF	30	mA	
Reverse Current @ 5V	lR	10	μA	
Power Dissipation	Pd	75	mW	
Operating Temperature Range	Тор	-40~+85	°C	
Storage Temperature Range	Тѕтс	-40~+85	°C	
Peak Pulsing Current (1/8 duty f = 1KHz)	lfp	125	mA	
Soldering Temperature	TSOL	Max 260°C for 5 sec Max		

# OPTICAL-ELECTRICAL CHARACTERISTICS

(TA=25°C)

Deremeter	Symbol	Test Condition	Value			Linit
Parameter			Min	Тур	Max	Unit
Luminous Intensity	١v	IF = 20mA	20	35	-	mcd
Forward Voltage	Vf	IF = 20mA	-	2.0	2.5	V
Reverse Leakage Current	lr	VR = 5V	-	-	10	μA
Viewing Angle at 50% Iv	201/2	IF = 20mA	-	140	-	Deg
Peak Wavelength	λP	IF = 20mA	-	575	-	nm
Dominant Wavelength	λD	IF = 20mA	565	570	576	nm

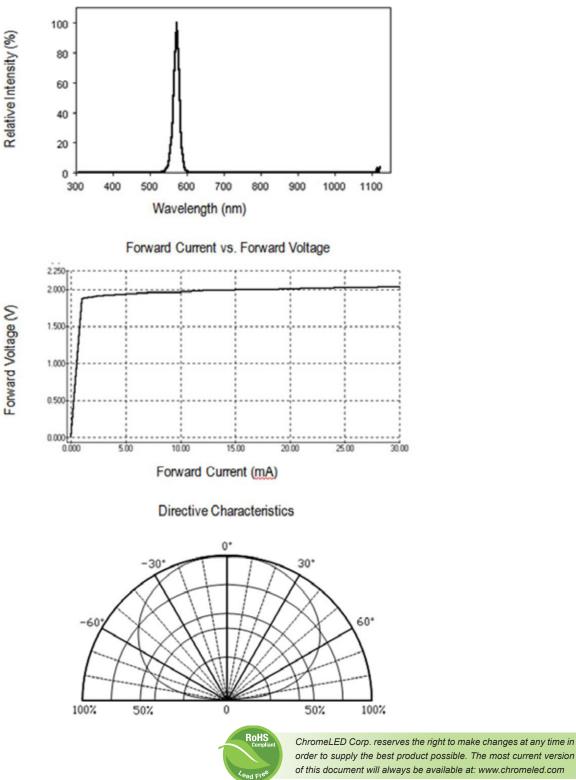
\*Tolerance of viewing angle: -10 / +5 deg.





## **OPTICAL CHARACTERISTIC CURVES**

Relative Intensity vs. Wavelength



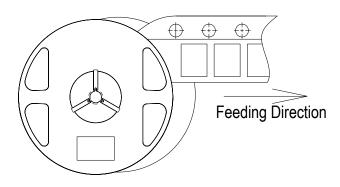
order to supply the best product possible. The most current version of this document will always be available at: www.chromeled.com

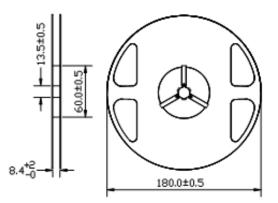


#### PACKAGING SPECIFICATION

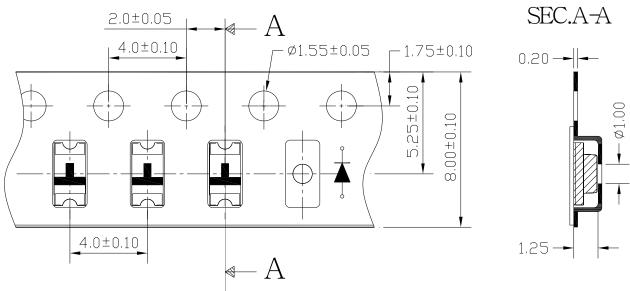
• Feeding Direction

• Dimensions of Reel (Unit: mm)





• Dimensions of Tape (Unit: mm)



#### Notes:

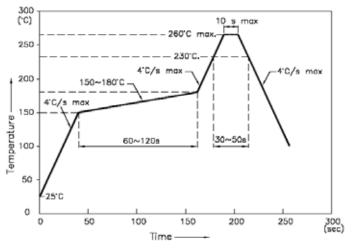
- 1. Empty component pockets are sealed with top cover tape;
- 2. The maximum number of missing lamps is two;
- 3. The cathode is oriented towards the tape sprocket hole.
- 4. 3,000pcs/Reel





### SOLDERING CONDITIONS

#### **REFLOW PROFILE**



#### NOTES:

- 1. We recommend the reflow temperature 245°C (±5°C).the maximum soldering temperature should be limited to 260°C.
- 2. dont cause stress to the epoxy resin while it is exposed to high temperature.
- 3. Number of reflow process shall be 2 times or less.
  - Soldering iron
  - Basic spec is  $\leq$  5sec when 260°C. If temperature is higher, time should be shorter
  - (+10°C → -1sec ).Power dissipation of iron should be smaller than 20W, and temperatures should be controllable .Surface temperature of the device should be under 230°C .

Rework

- 1. Customer must finish rework within 5 sec under 260°C.
- 2. The head of iron cannot touch copper foil.
- 3. Twin-head type is preferred.

